# Interface and switching (60V, 115mA)

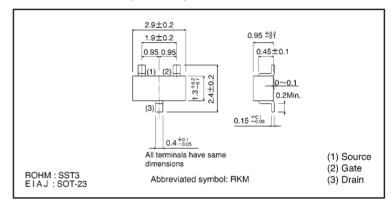
# **RK7002**

- Features
- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Low-voltage drive.
- 4) Easily designed drive circuits.
- 5) Easy to parallel.
- Structure

Silicon N-channel

**MOSFET** 

#### External dimensions (Units: mm)

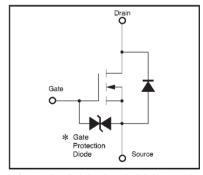


# ●Absolute maximum ratings (Ta = 25°C)

Parame	eter	Symbol	Symbol Limits	
Drain-source voltage		Voss	60	V
Gate-source voltage		Vgss	±20	V
Drain current	Continuous	lo	115	mA
Drain current	Pulsed	lop*1	800	mA
Reverse drain current	Continuous	IDR	115	mA
	Pulsed	IDRP*1	800	mA
Total power diss	dissipation P <sub>D</sub> *2 225		225	mW
Channel temperature		Tch	150	°C
Storage tempera	ature	Tstg	-55~+150 °C	

<sup>\*1</sup> Pw $\leq$ 10  $\mu$ s, Duty cycle $\leq$ 1%

# ●Equivalent circuit



\* A protection diode has been built in between the gate and the source to protect against static electricity when the product is in use. Use the protection circuit when fixed voltages are exceeded.

<sup>\*2</sup> When mounted on a 1  $\times$  0.75  $\times$  0.062 inch glass epoxy board.

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## ●Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Gate-source leakage	lgss	_	_	±10	μА	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V(BR) DSS	60	_	_	٧	I <sub>D</sub> =10 μ A, V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	_	_	1.0	μΑ	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V
Gate threshold voltage	VGS (th)	1.0	1.85	2.5	V	VDS=10V, ID=1mA
Static drain-source on-state	D/ *	_	_	7.5	Ω	ID=0.5A, VGS=10V
resistance	RDS (on)*	_	_	7.5		ID=0.05A, VGS=5V
Forward transfer admittance	Y <sub>fs</sub>  *	80	_	_	mS	ID=0.2A, VDS=10V
Input capacitance	Ciss	_	25	50	pF	V <sub>DS</sub> =25V
Output capacitance	Coss	_	10	25	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	_	3.0	5.0	pF	f=1MHz
Turn-on delay time	td (on)*	_	12	20	ns	ID=0.2A, VDD≒30V, VGS=10V,
Turn-off delay time	td (off)*	_	20	30	ns	$R_L=150\Omega$ , $R_G=10\Omega$

<sup>\*</sup> Pw≤300  $\mu$ s, Duty cycle≤1%

### Packaging specifications

	Package	Taping
Туре	Code	<b>T</b> 116
	Basic ordering unit (pieces)	3000
RK7002		0

#### Electrical characteristic curves

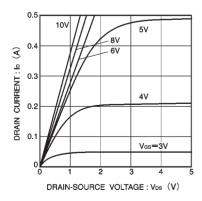


Fig.1 Typical output characteristics

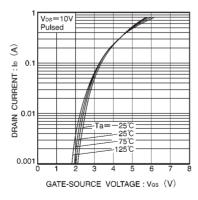


Fig.2 Typical transfer characteristics

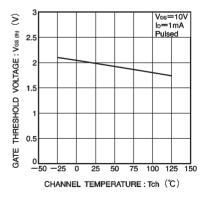
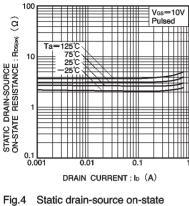


Fig.3 Gate threshold voltage vs. channel temperature

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STATIC DRAIN COURSE TO PRINCE DRAIN SOUTH OF THE PRINCE DRAIN CURRENT: Ib (A)

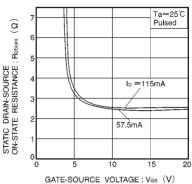


Fig.4 Static drain-source on-state resistance vs. drain current (I)

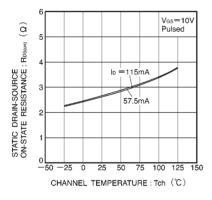
Fig.5 Static drain-source on-state resistance vs. drain current ( II )

3

V<sub>GS</sub>=0V

Pulsed

Fig.6 Static drain-source on-state resistance vs. gate-source voltage



SOURCE-DRAIN VOLTAGE: Vsb (V)

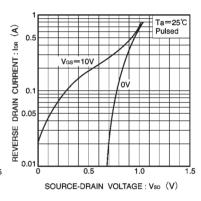


Fig.7 Static drain-source on-state resistance vs. channel temperature

Fig.8 Reverse drain current vs. source-drain voltage ( I )

Fig.9 Reverse drain current vs. source-drain voltage (I)

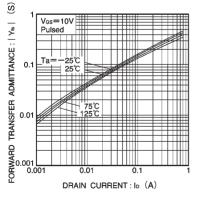


Fig.10 Forward transfer admittance vs. drain current

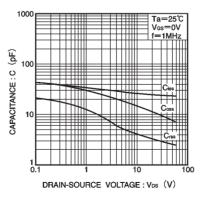


Fig.11 Typical capacitance vs. drain-source voltage

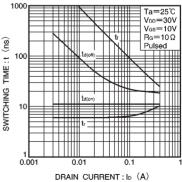


Fig.12 Switching characteristics
(See Figures 13 and 14 for the measurement circuit and resultant waveforms)

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Switching characteristics measurement circuit

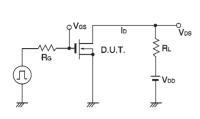


Fig.13 Switching time measurement circuit

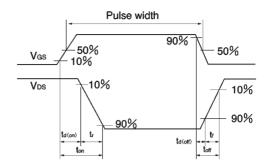


Fig.14 Switching time waveforms

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